TOSHIBA Field Effect Transistor Silicon P-Channel MOS Type (U-MOS III)

2SJ669

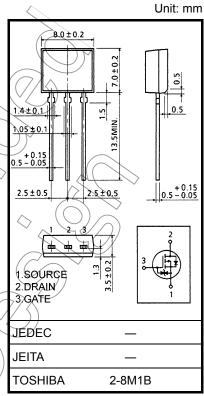
Relay Drive, DC/DC Converter and Motor Drive Applications

- 4-V gate drive
- Low drain-source ON-resistance: $R_{DS (ON)} = 0.12 \Omega (typ.)$
- High forward transfer admittance: |Y_{fs}| = 5.0 S (typ.)
- Low leakage current: I_{DSS} = -100 μA (max) (V_{DS} = -60 V)
- Enhancement mode: $V_{th} = -0.8$ to -2.0 V

$$(V_{DS} = -10 \text{ V}, I_{D} = -1 \text{ mA})$$

Absolute Maximum Ratings (Ta = 25°C)

Characteristic		Symbol	Rating	Unit
Drain-source voltage		V_{DSS}	-60	V
Drain-gate voltage (R _G	$_{\rm S}$ = 20 k Ω)	V_{DGR}	-60	V
Gate-source voltage		V_{GSS}	±20	V
Drain current	ID	ID <	-5,	A
	I_{DP}	I _{DP}	-20	<<
Drain power dissipation	1	P _D	1.2	W
Single-pulse avalanche	energy (Note 2)	EAS	40.5	mJ
Avalanche current		(I _{AR})	-5	N/A
Repetitive avalanche er	nergy (Note 3)	EAR	0.12	Cm/
Channel temperature		Tch	150	→°C
Storage temperature ra	nge	T _{stg}	-55 to 150)	°C



Weight: 0.54 g (typ.)

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Thermal Characteristics

Characteristic	Symbol	Max	Unit
Thermal resistance, channel to	ambient R _{th (ch-a)}	104	°C/W

- Note 1: The channel temperature should not exceed 150°C during use.
- Note 2: $V_{DD} = -25 \text{ V}$, $T_{ch} = 25^{\circ}\text{C}$ (initial), L = 2.2 mH, $R_G = 25 \Omega$, $I_{AR} = -5 \text{ A}$
- Note 3: Repetitive rating: pulse width limited by maximum channel temperature

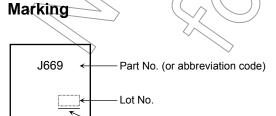
This transistor is an electrostatic-sensitive device. Handle with care.

Electrical Characteristics (Ta = 25°C)

Charac	eteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage cu	rrent	I _{GSS}	V _{GS} = ±16 V, V _{DS} = 0 V	_	_	±10	μΑ
Drain cutoff curre	ent	I _{DSS}	V _{DS} = -60 V, V _{GS} = 0 V	_	_	-100	μΑ
Drain-source breakdown voltage		V (BR) DSS	$I_D = -10 \text{ mA}, V_{GS} = 0 \text{ V}$	-60	_	_	V
		V (BR) DSX	$I_D = -10 \text{ mA}, V_{GS} = 20 \text{ V}$	-35	_	_	V
Gate threshold v	oltage	V _{th}	V _{DS} = -10 V, I _D = -1 mA	\ ₂ 0.8) >-	-2.0	V
Drain-source ON-resistance		D	V _{GS} = -4 V, I _D = -2.5 A	<u> </u>	0.16	0.25	Ω
		R _{DS} (ON)	V _{GS} = -10 V, I _D = -2.5 A))	0.12	0.17	
Forward transfer	admittance	Y _{fs}	V _{DS} = -10 V, I _D = -2.5 A	2.5	5.0	-	S
Input capacitance		C _{iss}		^ —	700	_	
Reverse transfer capacitance		C _{rss}	V _{DS} = -10 V, V _{GS} = 0 V, f = 1 MHz	_	60		pF
Output capacitance		Coss			9 0	<i>></i>	
Switching time	t _r	t _r	VGS PIP 72.5 A Output	-()14	> _	
	t _{on}	t _{on}	-10 V R _L = 12 Ω	7 (24	_	ns
	t _f	t _f	V _{DD} ≈ -30/√	2	14	_	
	t _{off}	t _{off}	Duty ≤ 1%, t _W ≠ 10 μs) —	95	_	
Total gate charge plus gate-drain)	e (gate-source	Qg		_	15	_	
Gate-source charge		Q _{gs} ($V_{DD} \approx -48 \text{ V}, V_{GS} = -10 \text{ V}, V_{D} = -5 \text{ A}$	_	11	_	nC
Gate-drain ("Miller") charge		Q _{gd}		_	4	_	

Source-Drain Ratings and Characteristics (Ta = 25°C)

Characteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
Continuous drain reverse current (Note 1)	10R	<u> </u>	_	_	-5	Α
Pulse drain reverse current (Note 1)) I _{DRP}	_	_	_	-20	Α
Forward voltage (diode)	V _{DSF}	$I_{DR} = -5 A$, $V_{GS} = 0 V$	_	_	1.7	٧
Reverse recovery time	t _{rr}	I _{DR} = -5 A, V _{GS} = 0 V	_	40	_	ns
Reverse recovery charge	Qrr	dl _{DR} / dt = 50 A / μs	_	32	_	nC



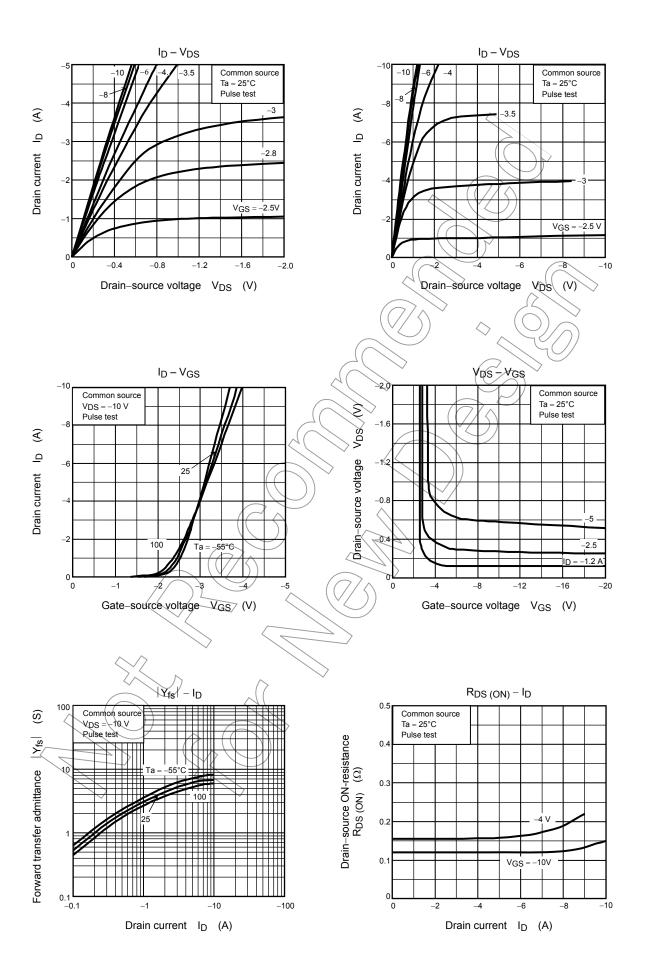
Note 4

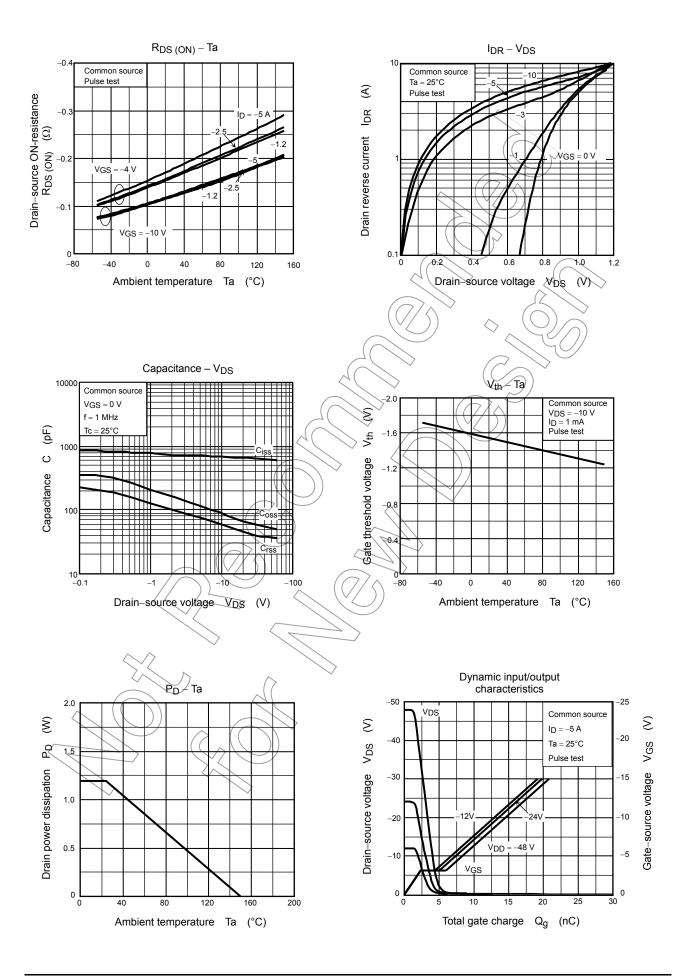
Note 4: A line under a Lot No. identifies the indication of product Labels.

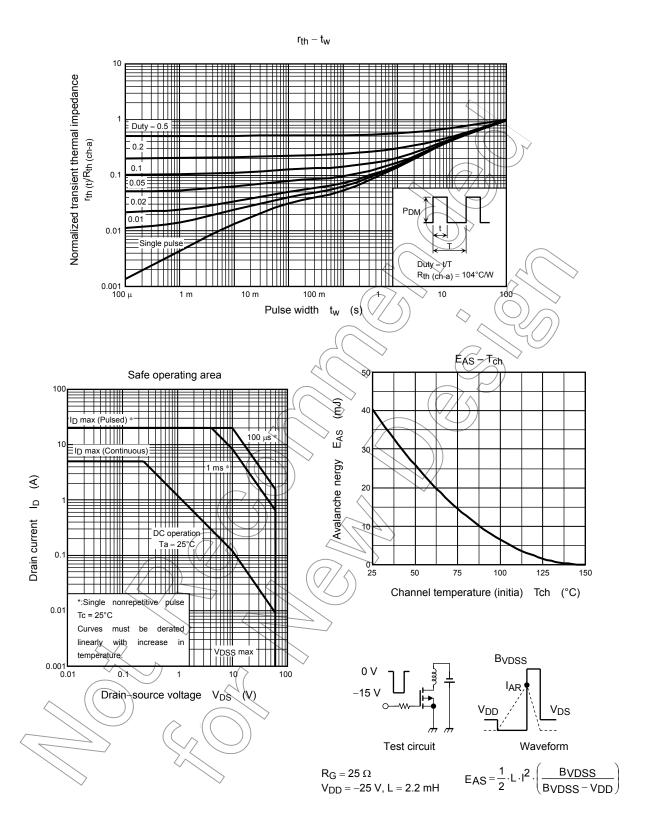
Not underlined: [[Pb]]/INCLUDES > MCV

Underlined: [[G]]/RoHS COMPATIBLE or [[G]]/RoHS [[Pb]]

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